



Note:

1.Material:

1.1 Housing: High temperature thermoplastic with g.f,UL94v-0

1.2 Contact: copper alloy,t=0.15mm

1.3 Shell: copper alloy,t=0.25mm

2.Specification:

2.1 Current rating: 1 A Max.

2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.

2.3 Contact resistance: 30 MΩ Max.

2.4 Insulation resistance: 100 MΩ Min.

2.5 Total mating force: 3.57 Kgf Max.

2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.

2.7 Temperature range: -30°C~80°C

RECOMMENDED PCB LAYOUT

A 01 S B 1 4 1 B 4-250

- ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩

- ① 产品代号 A:成品 ⑥ 端子材质 4:CS101R-BH
- ② 产品系列 01:micro usb 5p/n ⑦ 主体材质 1:LCP
- ③ 产品类别 S:母座 ⑧ 主体颜色 B:黑色
- ④ 产品类型 B:B TYPE ⑨ 下板类型 4:破板式
- ⑤ 外壳材质 1:C2800R-H ⑩ 细节流水 250:micro usb 5s B Type (破板式1.17)Smt四脚全贴无导线

2016.2.5		MATERIAL: SEE NOTE	
MODEL NO: XX		FINISH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	
TOLERANCE UNSPECIFIED		DR: 陈雅	
.x	0.15	CHK: 洪章波	
.xx	0.10	APP: 魏杰	
.xxx	0.05		
Ang.	1°		

 **深圳市裕诚电子有限公司**
SHENZHEN YUCHENG ELECTRONICS CO., LTD

TITLE:
Micro usb 5s B Type (破板式1.17)Smt四脚全贴无导线

DWG NO: **MICRO-4C69-Z** REV: **A**

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